

3.2x1.6mm SMD CHIP LED LAMP

Part Number: KP-3216SURCK Hyper Red

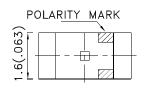
Features

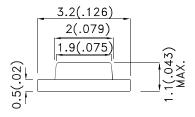
- 3.2mmx1.6mm SMT LED, 1.1mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

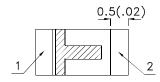
Description

The Hyper Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

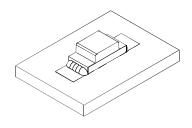
Package Dimensions











- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.2(0.0079") unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
KP-3216SURCK	Hyper Red (AlGaInP)	Water Clear	120	230	120°
		vvalei Ciedi	*40	*80	

Notes:

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.
- * Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.		Тур.		Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	650	*645		nm	IF=20mA		
λD [1]	Dominant Wavelength	Hyper Red	630	*630		nm IF=20mA			
Δλ1/2	Spectral Line Half-width	Hyper Red	28			nm	IF=20mA		
С	Capacitance	Hyper Red	35			pF	VF=0V;f=1MHz		
VF [2]	Forward Voltage	Hyper Red	1.95		2.5	V	IF=20mA		
IR	Reverse Current	Hyper Red	d		10	uA	V _R = 5V		

Notes:

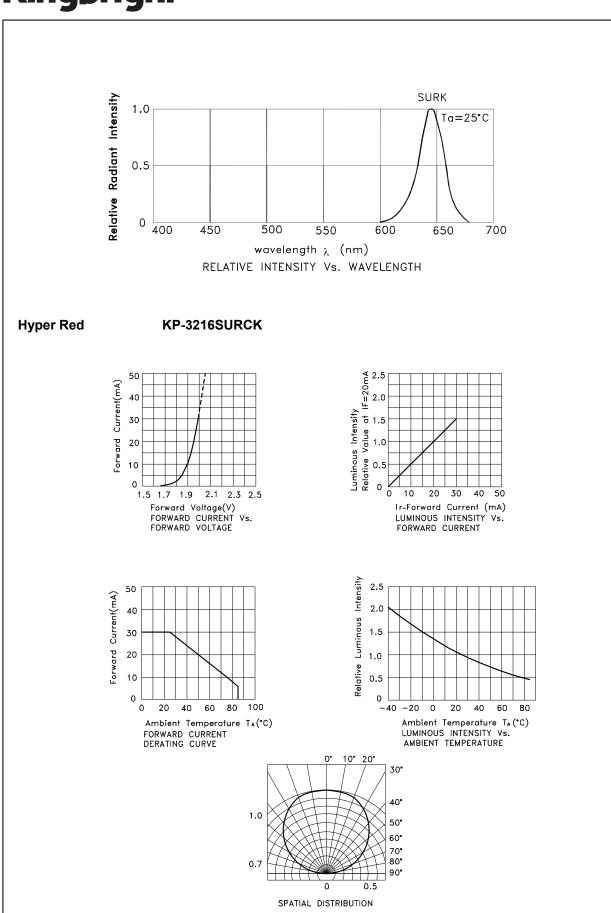
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.
- * Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red	Units		
Power dissipation	75	mW		
DC Forward Current	30	mA		
Peak Forward Current [1]	185	mA		
Reverse Voltage	5	V		
Operating Temperature	-40°C To +85°C			
Storage Temperature	-40°C To +85°C			

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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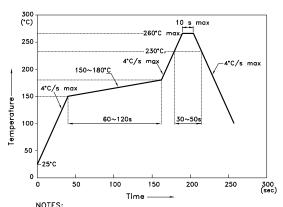
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



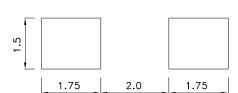
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

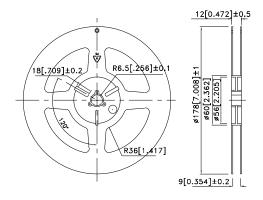
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 - to high temperature.

 3.Number of reflow process shall be 2 times or less.

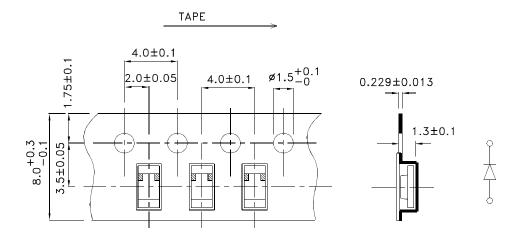
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Reel Dimension



Tape Dimensions (Units : mm)

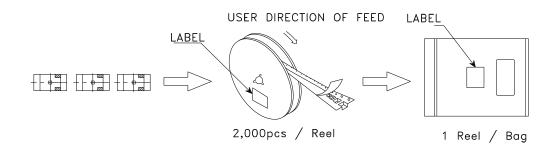


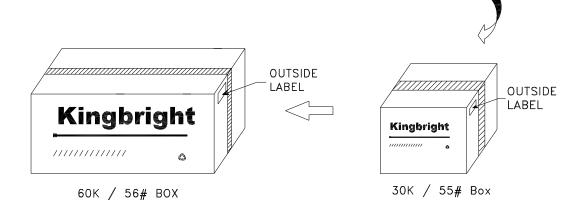
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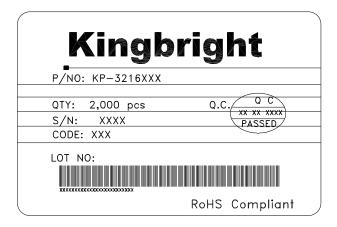
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PACKING & LABEL SPECIFICATIONS

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